











LT1013, LT1013D, LT1013M, LT1013AM

SLOS018I-MAY 1988-REVISED JULY 2016

LT1013x Dual Precision Operational Amplifier

Features

- Single-Supply Operation
 - Input Voltage Range Extends to Ground
 - Output Swings to Ground While Sinking Current
- Phase Reversal Protection
- Input Offset Voltage
 - 150 µV Maximum at 25°C for LT1013AM
- Offset-Voltage Temperature Coefficient
 - 2 μV/°C Maximum for LT1013AM
- Input Offset Current
 - 0.8 nA Maximum at 25°C for LT1013AM
- High Gain
 - 1.5 V/ μ V Minimum (R_L = 2 k Ω) for LT1013AM
 - 0.8 V/ μ V Minimum (R_I = 600 k Ω) for LT1013AM
- Low Supply Current
 - 0.5 mA Maximum at $T_A = 25$ °C for LT1013AM
- Low Peak-to-Peak Noise Voltage
 - 0.55 µV Typical
- Low Current Noise
 - 0.07 pA/√Hz Typical
- For Die Only Option, See LT1013-DIE

Applications

- Thermocouple Amplifiers
- Low-Side Current Measurement
- Instrumentation Amplifiers

3 Description

The LT1013x devices are dual precision operational amplifiers, featuring high gain, low supply current, low noise, and low-offset-voltage temperature coefficient.

The LT1013x devices can be operated from a single 5-V power supply; the common-mode input voltage range includes ground, and the output can also swing to within a few millivolts of ground. Crossover distortion is eliminated. The LT1013x can be operated with both dual ± 15-V and single 5-V supplies.

The LT1013C and LT1013D are characterized for operation from 0°C to 70°C. The LT1013DI is characterized for operation from -40°C to 105°C. The LT1013M, LT1013AM, and LT1013DM characterized for operation over the full military temperature range of -55°C to 125°C.

Device Information⁽¹⁾

| PART NUMBER | PACKAGE (PINS) | BODY SIZE (NOM) |
|-------------------------|----------------|-------------------|
| LT1013D LT1013DD | SOIC (8) | 4.90 mm × 3.91 mm |
| LT1013P LT1013DP | PDIP (8) | 9.81 mm × 6.35 mm |
| LT1013MFK LT1013AMFK | LCCC (20) | 8.89 mm × 8.89 mm |
| LT1013MJG LT1013AMJG | CDIP (8) | 9.60 mm × 6.67 mm |

(1) For all available packages, see the orderable addendum at the end of the data sheet.

Symbol (Each Amplifier)



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4 Revision History

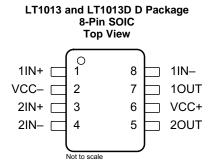
Changes from Revision H (November 2004) to Revision I

Page

- Added ESD Ratings table, Feature Description section, Device Functional Modes, Application and Implementation section, Power Supply Recommendations section, Layout section, Device and Documentation Support section, and Mechanical, Packaging, and Orderable Information section.



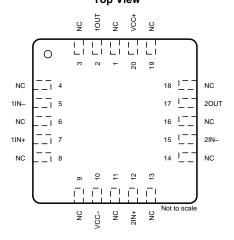
5 Pin Configuration and Functions



LT1013M and LT1013AM JG Package or LT1013 and LT1013D P Package 8-Pin CDIP or PDIP **Top View** 10UT [8 VCC+ 7 1IN- [2 20UT 3 6 1IN+ □ 2IN-5 VCC- [2IN+

Not to scale

LT1013M and LT1013AM FK Package 20-Pin LCCC Top View



Pin Functions

| | | PIN | | 1/0 | DESCRIPTION |
|------|------|--|------------|-----|----------------------------------|
| NAME | SOIC | LCCC | CDIP, PDIP | 1/0 | DESCRIPTION |
| 1IN+ | 1 | 7 | 3 | I | Noninverting input for channel 1 |
| 1IN- | 8 | 5 | 2 | I | Inverting input for channel 1 |
| 1OUT | 7 | 2 | 1 | 0 | Output for channel 1 |
| 2IN+ | 3 | 12 | 5 | I | Noninverting input for channel 2 |
| 2IN- | 4 | 15 | 6 | I | Inverting input for channel 2 |
| 2OUT | 5 | 17 | 7 | 0 | Output for channel 2 |
| NC | _ | 1, 3, 4, 6, 8, 9, 11, 13, 14, 16, 18, 19 | _ | _ | No internal connection |
| VCC+ | 6 | 20 | 8 | _ | Positive supply Voltage |
| VCC- | 2 | 10 | 4 | _ | Negative supply Voltage |



6 Specifications

6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)(1)

| | | | MIN | MAX | UNIT |
|-------------------------------------|---|------------|-------------------|-----------|------|
| V _{CC+} - V _{CC-} | Supply voltage ⁽²⁾ | | -0.3 | 44 | V |
| VI | Input voltage (any input) | | V _{CC} 5 | V_{CC+} | V |
| | Differential input voltage ⁽³⁾ | | | ±30 | V |
| | Duration of short-circuit current at (or below) 25°C(4) | | Unlim | ited | |
| | Case temperature for 60 s | FK package | | 260 | °C |
| | Lead temperature 1,6 mm (1/16 inch) from case for 10 s | JG package | | 300 | °C |
| T_J | Operating virtual junction temperature | | | 150 | °C |
| T _{stg} | Storage temperature | · | -65 | 150 | °C |

Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

6.2 ESD Ratings

| | | | VALUE | UNIT |
|---|-----------------------|---|-------|------|
| LT1013 | in D and P packages | | | |
| Electrostatic Human-body model (HBM), per ANSI/ESDA/JEDEC JS- | | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 ⁽¹⁾ | ±1000 | |
| V _(ESD) | discharge | Charged-device model (CDM), per JEDEC specification JESD22-C101 (2) | | V |
| LT1013 | D in D and P packages | | | |
| V Electrostatic | | static Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 (1) | | |
| $V_{(ESD)}$ | discharge | Charged-device model (CDM), per JEDEC specification JESD22-C101 (2) | ±500 | V |

JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

6.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

| | - | | MIN | MAX | UNIT |
|-------------------------------------|---------------------------|-----------------------------|------------------------|----------------------|------|
| V _{CC+} - V _{CC-} | Supply voltage | | 5 | 30 | V |
| | | LT1013C, LT1013D | 0 | 70 | |
| T _A | Ambient temperature | LT1013DI | -40 | 105 | °C |
| | | LT1013M, LT1013AM, LT1013DM | - 55 | 125 | |
| V | lanut common mode voltage | LT1013C, LT1013D, LT1013DI | V _{CC} - | V _{CC+} – 2 | \/ |
| V _{ICM} | Input common-mode voltage | LT1013M, LT1013AM, LT1013DM | V _{CC-} + 0.1 | V _{CC+} – 2 | V |

Supply voltage is V_{CC+} with respect to V_{CC-}. Differential voltage is IN+ with respect to IN-.

The output may be shorted to either supply.

JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.



6.4 Thermal Information

| | | | LT101 | 3x | | |
|----------------------|---|----------|----------|---------------------|---------------------|------|
| | THERMAL METRIC ⁽¹⁾ | D (SOIC) | P (PDIP) | FK (LCCC) | JG (CDIP) | UNIT |
| | | 8 PINS | 8 PINS | 20 PINS | 8 PINS | |
| $R_{\theta JA}$ | Junction-to-ambient thermal resistance (2)(3) | 101.6 | 49.5 | _ | _ | °C/W |
| $R_{\theta JC(top)}$ | Junction-to-case (top) thermal resistance | 47.6 | 38.7 | 35.7 ⁽⁴⁾ | 58.5 ⁽⁴⁾ | °C/W |
| $R_{\theta JB}$ | Junction-to-board thermal resistance | 42 | 26.7 | 34.8 | 82.9 | °C/W |
| ΨЈТ | Junction-to-top characterization parameter | 8.3 | 15.9 | _ | _ | °C/W |
| ΨЈВ | Junction-to-board characterization parameter | 41.5 | 26.6 | _ | _ | °C/W |
| $R_{\theta JC(bot)}$ | Junction-to-case (bottom) thermal resistance | _ | _ | 4.0 ⁽⁴⁾ | 10.8 ⁽⁴⁾ | °C/W |

- (1) For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report.
- (2) Maximum power dissipation is a function of $T_{J(max)}$, $R_{\theta JA}$, and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_{J(max)} T_A)/R_{\theta JA}$. Operating at the absolute maximum T_J of 150°C can affect reliability. Due to variation in individual device electrical characteristics and thermal resistance, the built-in thermal overload protection may be activated at power levels slightly above or below the rated dissipation.
- 3) The package thermal impedance is calculated in accordance with JESD 51-7.
- (4) R_{θJC(top)} and R_{θJC(bot)}thermal impedances are calculated in accordance with MIL-STD-883 for LCCC and CDIP

6.5 Electrical Characteristics: LT1013C, ±15 V

at specified free-air temperature, $V_{CC\pm} = \pm 15 \text{ V}$, $V_{IC} = 0$ (unless otherwise noted)

| | PARAMETER | TEST CONDITIONS | T _A ⁽¹⁾ | MIN | TYP ⁽²⁾ | MAX | UNIT | |
|------------------|---|---|-------------------------------|-------|--------------------|------|-------|------|
| ., | hand effect well- | D 50.0 | 25°C | | 60 | 300 | | |
| V_{IO} | Input offset voltage | $R_S = 50 \Omega$ | Full range | | | 400 | μV | |
| α_{VIO} | Temperature coefficient of input offset voltage | | Full range | | 0.4 | 2.5 | μV/°C | |
| | Long-term drift of input offset voltage | | 25°C | | 0.5 | | μV/mo | |
| | Input offset current | | 25°C | | 0.2 | 1.5 | nA | |
| I _{IO} | input onset current | | Full range | | | 2.8 | ΠA | |
| | lanut bina numant | | 25°C | | -15 | -30 | Λ | |
| I _{IB} | Input bias current | | Full range | | | -38 | nA | |
| V _{ICR} | Common-mode input voltage range | Danaman da dinaman | 25°C | -15 | | 13.5 | V | |
| VICR | | Recommended range | Full range | -15 | | 13 | V | |
| , Maximum r | Maximum peak output | D 210 | 25°C | ±12.5 | ±14 | | V | |
| VOM | V _{OM} voltage swing | $R_L = 2 k\Omega$ | Full range | ±12 | | | V | |
| | | $V_{O} = \pm 10 \text{ V}, R_{L} = 600 \Omega$ | 25°C | 0.5 | 0.2 | | | |
| A_{VD} | Large-signal differential | | V .40 V D 01-0 | 25°C | 1.2 | 7 | | V/µV |
| | voltage amplification | $V_O = \pm 10 \text{ V}, R_L = 2 \text{ k}\Omega$ | Full range | 0.7 | | | | |
| OMBD | | V _{IC} = −15 V to 13.5 V | 25°C | 97 | 114 | | -ID | |
| CMRR | Common-mode rejection ratio | V _{IC} = −14.9 V to 13 V | Full range | 94 | | | dB | |
| | Supply-voltage rejection ratio | V 0.V/ 40.V/ | 25°C | 100 | 117 | | in. | |
| k _{SVR} | (ΔVCC/ΔVIO) | $V_{CC+} = \pm 2 \text{ V to } \pm 18 \text{ V}$ | Full range | 97 | | | dB | |
| | Channel separation | $V_O = \pm 10 \text{ V}, R_L = 2 \text{ k}\Omega$ | 25°C | 120 | 137 | | dB | |
| r _{id} | Differential input resistance | | 25°C | 70 | 300 | | MΩ | |
| r _{ic} | Common-mode input resistance | | 25°C | | 4 | | GΩ | |
| | Complete access to an area 200 | | 25°C | | 0.35 | 0.55 | A | |
| I _{CC} | Supply current per amplifier | | Full range | | | 0.7 | mA | |

⁽¹⁾ Full range is 0°C to 70°C.

(2) All typical values are at $T_A = 25$ °C.



6.6 Electrical Characteristics: LT1013C, 5 V

at specified free-air temperature, $V_{CC+} = 5 \text{ V}$, $V_{CC-} = 0$, $V_O = 1.4 \text{ V}$, $V_{IC} = 0$ (unless otherwise noted)

| | PARAMETER | TEST CONDITIONS | T _A ⁽¹⁾ | MIN | TYP ⁽²⁾ | MAX | UNIT |
|------------------|---|---|-------------------------------|-----|--------------------|------|------|
| , | lanut offect valters | D 50.0 | 25°C | | 90 | 450 | \/ |
| V _{IO} | Input offset voltage | $R_S = 50 \Omega$ | Full range | | | 570 | μV |
| i | land that were | | 25°C | | 0.3 | 2 | ^ |
| Ю | Input offset current | | Full range | | | 6 | nA |
| | Inc. A black comment | | 25°C | | -18 | -50 | A |
| IB | B Input bias current | | Full range | | | -90 | nA |
| V 0 | O | D | 25°C | 0 | | 3.5 | V |
| V _{ICR} | ICR Common-mode input voltage range | Recommended range | Full range | 0 | | 3 | V |
| | | Output low, No load | 25°C | | 15 | 25 | |
| | | Output law B 600 C to CND | 25°C | | 5 | 10 | |
| | | Output low, $R_L = 600 \Omega$ to GND | Full range | | | 13 | |
| V _{OM} | Maximum peak output voltage swing | Output low, I _{sink} = 1 mA | 25°C | | 220 | 350 | V |
| | | Output high, No load | 25°C | 4 | 4.4 | | |
| | | Outside Books OND | 25°C | 3.4 | 4 | | |
| | | Output high, $R_L = 600 \Omega$ to GND | Full range | 3.2 | | | |
| A _{VD} | Large-signal differential voltage amplification | $V_O = 5$ mV to 4 V, $R_L = 500 \Omega$ | 25°C | | 1 | | V/µV |
| | Cumbic current ner amplifier | | 25°C | | 0.32 | 0.5 | A |
| CC | Supply current per amplifier | | Full range | | | 0.55 | mA |
| I _{CC} | Supply current per amplifier | | | | | | |

6.7 Electrical Characteristics: LT1013D, ±15 V

at specified free-air temperature, $V_{CC\pm} = \pm 15 \text{ V}$, $V_{IC} = 0$ (unless otherwise noted)

| | PARAMETER | TEST CONDITIONS | T _A ⁽¹⁾ | MIN | TYP ⁽²⁾ | MAX | UNIT |
|-----------------------|---|---|-------------------------------|-------|--------------------|------|-----------|
| W | Input offset voltage | P - 50 O | 25°C | | 200 | 800 | μV |
| V_{IO} | input onset voltage | $R_S = 50 \Omega$ | Full range | | | 1000 | μν |
| α_{VIO} | Temperature coefficient of input offset voltage | | Full range | | 0.7 | 5 | μV/°C |
| | Long-term drift of input offset voltage | | 25°C | | 0.5 | | μV/mo |
| | Input offset current | | 25°C | | 0.2 | 1.5 | nA |
| I _{IO} | input onset current | | Full range | | | 2.8 | IIA |
| l.a | lanut biog gurrant | | 25°C | | -15 | -30 | Λ |
| I _{IB} | Input bias current | | Full range | | | -38 | nA |
| V | Common-mode input voltage range | Decemmended range | 25°C | -15 | | 13.5 | V |
| V _{ICR} | Common-mode input voltage range | Recommended range | Full range | -15 | | 13 | V |
| V | Maximum made output valtage quing | D 2ko | 25°C | ±12.5 | ±14 | | V |
| V_{OM} | Maximum peak output voltage swing | $R_L = 2 k\Omega$ | Full range | ±12 | | | |
| | | $V_O = \pm 10 \text{ V}, R_L = 600 \Omega$ | 25°C | 0.5 | 2 | | |
| A_{VD} | Large-signal differential voltage amplification | $V_O = \pm 10 \text{ V}, R_L = 2 \text{ k}\Omega$ | 25°C | 1.2 | 7 | | V/µV |
| | | $V_0 = \pm 10 \text{ V}, R_L = 2 \text{ K} 22$ | Full range | 0.7 | | | |
| CMRR | Common-mode rejection ratio | V _{IC} = −15 V to 13.5 V | 25°C | 97 | 114 | | dB |
| CIVIKK | Common-mode rejection ratio | $V_{IC} = -14.9 \text{ V to } 13 \text{ V}$ | Full range | 94 | | | uБ |
| l _e | Supply-voltage rejection ratio (ΔVCC/ΔVIO) | \/ - +2\/ to +19\/ | 25°C | 100 | 117 | | dB |
| k _{SVR} | Supply-voltage rejection ratio (ΔVCC/ΔVIO) | $V_{CC+} = \pm 2 \text{ V to } \pm 18 \text{ V}$ | Full range | 97 | | | uБ |
| | Channel separation | $V_O = \pm 10 \text{ V}, R_L = 2 \text{ k}\Omega$ | 25°C | 120 | 137 | | dB |
| r _{id} | Differential input resistance | | 25°C | 70 | 300 | | $M\Omega$ |
| r _{ic} | Common-mode input resistance | | 25°C | | 4 | | GΩ |
| ı | Supply gurrent per amplifier | | 25°C | | 0.35 | 0.55 | mΛ |
| I _{CC} | Supply current per amplifier | | Full range | | | 0.6 | mA |

Full range is 0°C to 70°C.

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⁽¹⁾ Full range is 0°C to 70°C.
(2) All typical values are at T_A = 25°C.

⁽²⁾ All typical values are at $T_A = 25$ °C.



6.8 Electrical Characteristics: LT1013D, 5 V

at specified free-air temperature, $V_{CC_+} = 5 \text{ V}$, $V_{CC_-} = 0$, $V_O = 1.4 \text{ V}$, $V_{IC} = 0$ (unless otherwise noted)

| | PARAMETER | TEST CONDITIONS | T _A ⁽¹⁾ | MIN | TYP ⁽²⁾ | MAX | UNIT |
|-----------------|---|---|-------------------------------|-----|--------------------|------|------|
| ., | land offer to the se | D 50.0 | 25°C | | 250 | 950 | |
| V _{IO} | Input offset voltage | $R_S = 50 \Omega$ | Full range | | | 1200 | μV |
| | Innut offeet current | | 25°C | | 0.3 | 2 | - A |
| I _{IO} | Input offset current | | Full range | | | 6 | nA |
| | Innuit biog gurrant | | 25°C | | -18 | -50 | - A |
| I _{IB} | Input bias current | | Full range | | | -90 | nA |
| ٧ ٥ | Common-mode input voltage range | Decemberded range | 25°C | 0 | | 3.5 | V |
| VICR | | Recommended range | Full range | 0 | | 3 | V |
| | | Output low, No load | 25°C | | 15 | 25 | |
| | Output low, $R_1 = 600 \Omega$ to GND | 25°C | | 5 | 10 | | |
| | | Output low, K _L = 600 12 to GIND | Full range | | | 13 | |
| V_{OM} | Maximum peak output voltage swing | Output low, I _{sink} = 1 mA | 25°C | | 220 | 350 | V |
| | | Output high, No load | 25°C | 4 | 4.4 | | |
| | | Outside D. COO O to CND | 25°C | 3.4 | 4 | | |
| | | Output high, $R_L = 600 \Omega$ to GND | Full range | 3.2 | | | |
| A _{VD} | Large-signal differential voltage amplification | V_O = 5 mV to 4 V, R_L = 500 Ω | 25°C | | 1 | | V/µV |
| | Supply ourrent per amplifier | | 25°C | | 0.32 | 0.5 | A |
| I _{CC} | Зирріу сипені рег атірішег | upply current per amplifier | Full range | | | 0.55 | mA |

6.9 Electrical Characteristics: LT1013DI, ±15 V

at specified free-air temperature, $V_{CC\pm} = \pm 15$ V, $V_{IC} = 0$ (unless otherwise noted)

| | PARAMETER | TEST CONDITIONS | T _A ⁽¹⁾ | MIN | TYP ⁽²⁾ | MAX | UNIT |
|------------------|---|---|-------------------------------|------------|--------------------|------|-----------|
| ., | land the trade of | D 500 | 25°C | | 200 | 800 | / |
| V_{IO} | Input offset voltage | $R_S = 50 \Omega$ | Full range | | | 1000 | μV |
| α_{VIO} | Temperature coefficient of input offset voltage | | Full range | | 0.7 | 5 | μV/°C |
| | Long-term drift of input offset voltage | | 25°C | | 0.5 | | μV/mo |
| | Input offset current | | 25°C | | 0.2 | 1.5 | nA |
| I _{IO} | input onset current | | Full range | | | 2.8 | ПА |
| | Input bigg gurrent | | 25°C | | -15 | -30 | nA |
| I _{IB} | Input bias current | | Full range | | | -38 | ΠA |
| ., | Common-mode input voltage range | Decemmended range | 25°C | -15 | | 13.5 | V |
| V_{ICR} | 3 Common-mode input voltage range | Recommended range | Full range | -15 | | 13 | V |
| ., | DM Maximum peak output voltage swing | D 210 | 25°C | ±12.5 | ±14 | | V |
| V_{OM} | | Maximum peak output voltage swing N _L = 2 N ₂ | $R_L = 2 k\Omega$ | Full range | ±12 | | |
| | | $V_{O} = \pm 10 \text{ V}, R_{L} = 600 \Omega$ | 25°C | 0.5 | 0.2 | | |
| A_{VD} | Large-signal differential voltage amplification | V .40 V D .01-0 | 25°C | 1.2 | 7 | | V/µV |
| | | $V_O = \pm 10 \text{ V}, R_L = 2 \text{ k}\Omega$ | Full range | 0.7 | | | |
| CMRR | Common mode rejection ratio | $V_{IC} = -15 \text{ V to } 13.5 \text{ V}$ | 25°C | 97 | 114 | | dB |
| CIVIRR | Common-mode rejection ratio | V _{IC} = −14.9 V to 13 V | Full range | 94 | | | uв |
| le. | Cumply valtage rejection ratio (A)/CC/A)/IO) | \\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\ | 25°C | 100 | 117 | | dB |
| k _{SVR} | Supply-voltage rejection ratio (ΔVCC/ΔVIO) | $V_{CC+} = \pm 2 \text{ V to } \pm 18 \text{ V}$ | Full range | 97 | | | uв |
| | Channel separation | $V_O = \pm 10 \text{ V}, R_L = 2 \text{ k}\Omega$ | 25°C | 120 | 137 | | dB |
| r _{id} | Differential input resistance | | 25°C | 70 | 300 | | $M\Omega$ |
| r _{ic} | Common-mode input resistance | | 25°C | | 4 | | GΩ |
| | Cumbic current ner amplifier | | 25°C | | 0.35 | 0.55 | A |
| I _{CC} | Supply current per amplifier | | Full range | | | 0.6 | mA |

Full range is -40°C to 105°C.

⁽¹⁾ Full range is 0°C to 70°C.
(2) All typical values are at T_A = 25°C.

All typical values are at $T_A = 25$ °C.



6.10 Electrical Characteristics: LT1013DI, 5 V

at specified free-air temperature, $V_{CC_+} = 5 \text{ V}$, $V_{CC_-} = 0$, $V_O = 1.4 \text{ V}$, $V_{IC} = 0$ (unless otherwise noted)

| | PARAMETER | TEST CONDITIONS | T _A ⁽¹⁾ | MIN | TYP ⁽²⁾ | MAX | UNIT |
|------------------|---|---|-------------------------------|-----|--------------------|------|------|
| ., | land offertually as | B 50.0 | 25°C | | 250 | 950 | |
| V _{IO} | Input offset voltage | $R_S = 50 \Omega$ | Full range | | | 1200 | μV |
| | land offers a surrent | | 25°C | | 0.3 | 2 | nA |
| I _{IO} | Input offset current | | Full range | | | 6 | nA |
| | lanut biog gurrant | | 25°C | | -18 | -50 | nA |
| I _{IB} | Input bias current | | Full range | | | -90 | ΠA |
| \/ | Common mode insult voltage vange | December ded venue | 25°C | 0 | | 3.5 | V |
| V _{ICR} | Common-mode input voltage range | Recommended range | Full range | 0 | | 3 | ٧ |
| | | Output low, No load | 25°C | | 15 | 25 | |
| | | Output law D. COO O to CND | 25°C | | 5 | 10 | |
| | | Output low, $R_L = 600 \Omega$ to GND | Full range | | | 13 | |
| V_{OM} | Maximum peak output voltage swing | Output low, I _{sink} = 1 mA | 25°C | | 220 | 350 | V |
| | | Output high, No load | 25°C | 4 | 4.4 | | |
| | | Output high, $R_1 = 600 \Omega$ to GND | 25°C | 3.4 | 4 | | |
| | | Output high, R _L = 800 12 to GND | Full range | 3.2 | | | |
| A _{VD} | Large-signal differential voltage amplification | V_{O} = 5 mV to 4 V, R_{L} = 500 Ω | 25°C | | 1 | | V/µV |
| | Cumply current new arm lifter | | 25°C | | 0.32 | 0.5 | A |
| I _{cc} | Supply current per amplifier | | Full range | | | 0.55 | mA |

⁽¹⁾ Full range is -40°C to 105°C.

6.11 Electrical Characteristics: LT1013M, ±15 V

at specified free-air temperature, $V_{CC\pm} = \pm 15 \text{ V}$, $V_{IC} = 0$ (unless otherwise noted)

| | PARAMETER | TEST CONDITIONS | T _A ⁽¹⁾ | MIN | TYP ⁽²⁾ | MAX | UNIT |
|-----------------------|---|---|-------------------------------|-------|--------------------|--------------------|-------|
| 1/ | Innut offect vallege | D 50.0 | 25°C | | 60 | 300 | \/ |
| V_{IO} | Input offset voltage | $R_S = 50 \Omega$ | Full range | | | 550 | μV |
| α_{VIO} | Temperature coefficient of input offset voltage | | Full range | | 0.5 | 2.5 ⁽³⁾ | μV/°C |
| | Long-term drift of input offset voltage | | 25°C | | 0.5 | | μV/mo |
| | Input offect current | | 25°C | | 0.2 | 1.5 | ~ A |
| I _{IO} | Input offset current | | Full range | | | 5 | nA |
| | lament him a summer | | 25°C | | -15 | -30 | A |
| I _{IB} | Input bias current | | Full range | | | -45 | nA |
| ., | 0 1 1 1 | | 25°C | -15 | | 13.5 | ., |
| V_{ICR} | Common-mode input voltage range | Recommended range | Full range | -14.9 | | 13 | V |
| ., | | D 010 | 25°C | ±12.5 | ±14 | | ., |
| V_{OM} | Maximum peak output voltage swing | $R_L = 2 k\Omega$ | Full range | ±11.5 | | | V |
| | | $V_{O} = \pm 10 \text{ V}, R_{L} = 600 \Omega$ | 25°C | 0.5 | 2 | | |
| A_{VD} | Large-signal differential voltage amplification | V .40 V D 01:0 | 25°C | 1.2 | 7 | | V/µV |
| | | $V_O = \pm 10 \text{ V}, R_L = 2 \text{ k}\Omega$ | Full range | 0.25 | | | |
| CMDD | 0 | V _{IC} = −15 V to 13.5 V | 25°C | 97 | 117 | | -ID |
| CMRR | Common-mode rejection ratio | V _{IC} = −14.9 V to 13 V | Full range | 94 | | | dB |
| ı. | C | V :0.V/+= :40.V/ | 25°C | 100 | 117 | | -ID |
| k _{SVR} | Supply-voltage rejection ratio (ΔVCC/ΔVIO) | $V_{CC+} = \pm 2 \text{ V to } \pm 18 \text{ V}$ | Full range | 97 | | | dB |
| | Channel separation | $V_O = \pm 10 \text{ V}, R_L = 2 \text{ k}\Omega$ | 25°C | 120 | 137 | | dB |
| r _{id} | Differential input resistance | | 25°C | 70 | 300 | | МΩ |
| r _{ic} | Common-mode input resistance | | 25°C | | 4 | | GΩ |
| | Constitution of the constitution | | 25°C | | 0.35 | 0.55 | A |
| I _{CC} | Supply current per amplifier | | Full range | | | 0.7 | mA |

¹⁾ Full range is -55°C to 125°C.

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⁽²⁾ All typical values are at $T_A = 25$ °C.

²⁾ All typical values are at $T_A = 25$ °C.

⁽³⁾ On products compliant to MIL-PRF-38535, Class B, this parameter is not production tested.



6.12 Electrical Characteristics: LT1013M, 5 V

at specified free-air temperature, $V_{CC+} = 5 \text{ V}$, $V_{CC-} = 0$, $V_O = 1.4 \text{ V}$, $V_{IC} = 0$ (unless otherwise noted)

| | PARAMETER | TEST CONDITIONS | T _A ⁽¹⁾ | MIN | TYP ⁽²⁾ | MAX | UNIT |
|------------------|--|---|-------------------------------|-----|--------------------|------|------|
| | | B 50.0 | 25°C | | 90 | 450 | |
| V_{IO} | Input offset voltage | $R_S = 50 \Omega$ | Full range | | 400 | 1500 | μV |
| | | $R_S = 50 \Omega$, $V_{IC} = 0.1 V$ | 125°C | | 200 | 750 | |
| | lanut offeet europt | | 25°C | | 0.3 | 2 | - 1 |
| I _{IO} | Input offset current | | Full range | | | 10 | nA |
| | Land bin a summer | | 25°C | | -18 | -50 | 0 |
| I _{IB} | Input bias current | | Full range | | | -120 | nA |
| ., | Occurred to the state of the st | D | 25°C | 0 | | 3.5 | |
| V _{ICR} | Common-mode input voltage range | Recommended range | Full range | 0 | | 3 | V |
| | | Output low, No load | 25°C | | 15 | 25 | |
| | | Outrat law D. 200 O to OND | 25°C | | 5 | 10 | |
| | | Output low, $R_L = 600 \Omega$ to GND | Full range | | | 18 | |
| V_{OM} | Maximum peak output voltage swing | Output low, I _{sink} = 1 mA | 25°C | | 220 | 350 | V |
| | | Output high, No load | 25°C | 4 | 4.4 | | |
| | | Output high D COO O to OND | 25°C | 3.4 | 4 | | |
| | | Output high, $R_L = 600 \Omega$ to GND | Full range | 3.1 | | | |
| A _{VD} | Large-signal differential voltage amplification | V_{O} = 5 mV to 4 V, R_{L} = 500 Ω | 25°C | | 1 | | V/µV |
| | Ourante constant and a second life and | | 25°C | | 0.32 | 0.5 | 4 |
| I _{CC} | Supply current per amplifier | | Full range | | | 0.65 | mA |

⁽¹⁾ Full range is -55°C to 125°C.

6.13 Electrical Characteristics: LT1013AM, ±15 V

at specified free-air temperature, $V_{CC\pm} = \pm 15 \text{ V}$, $V_{IC} = 0$ (unless otherwise noted)

| | PARAMETER | TEST CONDITIONS | T _A ⁽¹⁾ | MIN | TYP ⁽²⁾ | MAX | UNIT |
|------------------|---|--|-------------------------------|-------|--------------------|------|-------|
| ., | | B 50.0 | 25°C | | 40 | 150 | ., |
| V_{IO} | Input offset voltage | $R_S = 50 \Omega$ | Full range | | | 300 | μV |
| α_{VIO} | Temperature coefficient of input offset voltage | | Full range | | 0.4 | 2(3) | μV/°C |
| | Long-term drift of input offset voltage | | 25°C | | 0.4 | | μV/mo |
| | lanut offeet current | | 25°C | | 0.15 | 0.8 | nA |
| 10 | Input offset current | | Full range | | | 2.5 | ΠA |
| 1 | lanut bigg gurrant | | 25°C | | -12 | -20 | nA |
| IB | Input bias current | | Full range | | | -30 | ΠA |
| ., | Common mode input valtage range | Decemberded rooms | 25°C | -15 | | 13.5 | V |
| V_{ICR} | Common-mode input voltage range | Recommended range | Full range | -14.9 | | 13 | V |
| ., | Maximum pook output voltage aving | D 210 | 25°C | ±13 | ±14 | | V |
| V _{OM} | Maximum peak output voltage swing | $R_L = 2 k\Omega$ | Full range | ±12 | | | V |
| | | $V_O = \pm 10 \text{ V}, R_L = 600 \Omega$ | 25°C | 0.8 | 2.5 | | |
| A_{VD} | Large-signal differential voltage amplification | $V_{\Omega} = \pm 10 \text{ V}, R_{1} = 2 \text{ k}\Omega$ | 25°C | 1.5 | 8 | | V/µV |
| | | $V_0 = \pm 10 \text{ V}, R_L = 2 \text{ K}\Omega$ | Full range | 0.5 | | | |
| OMDD | 0 | V _{IC} = −15 V to 13.5 V | 25°C | 100 | 117 | | dB |
| CMRR | Common-mode rejection ratio | V _{IC} = -14.9 V to 13 V | Full range | 97 | | | ав |
| 1- | Complete and a significant and in (AV/CC/AV/IC) | V :0.V/+- :40.V/ | 25°C | 103 | 120 | | ٦D |
| k _{SVR} | Supply-voltage rejection ratio (ΔVCC/ΔVIO) | $V_{CC+} = \pm 2 \text{ V to } \pm 18 \text{ V}$ | Full range | 100 | | | dB |
| | Channel separation | $V_O = \pm 10 \text{ V}, R_L = 2 \text{ k}\Omega$ | 25°C | 123 | 140 | | dB |
| r _{id} | Differential input resistance | | 25°C | 100 | 400 | | ΜΩ |
| r _{ic} | Common-mode input resistance | | 25°C | | 5 | | GΩ |
| 1 | Cumply overent nor amplifier | | 25°C | | 0.35 | 0.5 | A |
| I _{CC} | Supply current per amplifier | | Full range | | | 0.6 | mA |

Full range is -55°C to 125°C.

All typical values are at $T_A = 25$ °C.

All typical values are at T_A = 25°C. On products compliant to MIL-PRF-38535, Class B, this parameter is not production tested.



6.14 Electrical Characteristics: LT1013AM, 5 V

at specified free-air temperature, $V_{CC+} = 5 \text{ V}$, $V_{CC-} = 0$, $V_O = 1.4 \text{ V}$, $V_{IC} = 0$ (unless otherwise noted)

| | PARAMETER | TEST CONDITIONS | T _A ⁽¹⁾ | MIN | TYP ⁽²⁾ | MAX | UNIT |
|------------------|---|---|-------------------------------|-----|--------------------|------|------|
| | | P. 50.0 | 25°C | | 60 | 250 | |
| V_{IO} | Input offset voltage | $R_S = 50 \Omega$ | Full range | | 250 | 900 | μV |
| | | $R_S = 50 \Omega$, $V_{IC} = 0.1 V$ | 125°C | | 120 | 450 | |
| | land offert coment | | 25°C | | 0.2 | 1.3 | - A |
| I _{IO} | Input offset current | | Full range | | | 6 | nA |
| | land him amount | | 25°C | | -15 | -35 | A |
| I _{IB} | Input bias current | | Full range | | | -80 | nA |
| ., | Occurred to the instant with the second | December of the second | 25°C | 0 | | 3.5 | |
| V _{ICR} | Common-mode input voltage range | Recommended range | Full range | 0 | | 3 | V |
| | | Output low, No load | 25°C | | 15 | 25 | |
| | | Outside Law D. 1999 O. La CNID | 25°C | | 5 | 10 | |
| | | Output low, $R_L = 600 \Omega$ to GND | Full range | | | 15 | |
| V_{OM} | Maximum peak output voltage swing | Output low, I _{sink} = 1 mA | 25°C | | 220 | 350 | V |
| | | Output high, No load | 25°C | 4 | 4.4 | | |
| | | 0 + +111 - 0 - 000 0 + - 0110 | 25°C | 3.4 | 4 | | |
| | | Output high, $R_L = 600 \Omega$ to GND | Full range | 3.2 | | | |
| A _{VD} | Large-signal differential voltage amplification | V_{O} = 5 mV to 4 V, R_{L} = 500 Ω | 25°C | | 1 | | V/µV |
| | 0 1 1" | | 25°C | | 0.31 | 0.45 | |
| I _{CC} | Supply current per amplifier | | Full range | | | 0.55 | mA |

⁽¹⁾ Full range is -55°C to 125°C.

6.15 Electrical Characteristics: LT1013DM, ±15 V

at specified free-air temperature, $V_{CC\pm} = \pm 15 \text{ V}$, $V_{IC} = 0$ (unless otherwise noted)

| | PARAMETER | TEST CONDITIONS | T _A ⁽¹⁾ | MIN | TYP ⁽²⁾ | MAX | UNIT |
|-----------------------|---|---|-------------------------------|-------|--------------------|--------------------|-----------|
| V | Input offset voltage | D 50.0 | 25°C | | 200 | 800 | μV |
| V_{IO} | input offset voltage | $R_S = 50 \Omega$ | Full range | | | 1000 | μν |
| α_{VIO} | Temperature coefficient of input offset voltage | | Full range | | 0.5 | 2.5 ⁽³⁾ | μV/°C |
| | Long-term drift of input offset voltage | | 25°C | | 0.5 | | μV/mo |
| | Input offset current | | 25°C | | 0.2 | 1.5 | nA |
| I _{IO} | input onset current | | Full range | | | 5 | IIA |
| | Input bias current | | 25°C | | -15 | -30 | nA |
| I _{IB} | input bias current | | Full range | | | -45 | IIA |
| 1 \/ | Common-mode input voltage range | Recommended range | 25°C | -15 | | 13.5 | V |
| V_{ICR} | Common-mode input voltage range | Recommended range | Full range | -14.9 | | 13 | V |
| 11/ | Maximum pook autout valtage aving | D 210 | 25°C | ±12.5 | ±14 | | V |
| V _{OM} | Maximum peak output voltage swing | $R_L = 2 k\Omega$ | Full range | ±11.5 | | | V |
| | | $V_O = \pm 10 \text{ V}, R_L = 600 \Omega$ | 25°C | 0.5 | 2 | | |
| A_{VD} | Large-signal differential voltage amplification | V .40 V B 2 k0 | 25°C | 1.2 | 7 | | V/µV |
| | | $V_O = \pm 10 \text{ V}, R_L = 2 \text{ k}\Omega$ | Full range | 0.25 | | | |
| CMDD | O | V _{IC} = −15 V to 13.5 V | 25°C | 97 | 114 | | -ID |
| CMRR | Common-mode rejection ratio | V _{IC} = −14.9 V to 13 V | Full range | 94 | | | dB |
| 1. | 0 | V .0.V/+40.V/ | 25°C | 100 | 117 | | dB |
| k _{SVR} | Supply-voltage rejection ratio (ΔVCC/ΔVIO) | $V_{CC+} = \pm 2 \text{ V to } \pm 18 \text{ V}$ | Full range | 97 | | | ав |
| | Channel separation | $V_O = \pm 10 \text{ V}, R_L = 2 \text{ k}\Omega$ | 25°C | 120 | 137 | | dB |
| r _{id} | Differential input resistance | | 25°C | 70 | 300 | | ΜΩ |
| r _{ic} | Common-mode input resistance | | 25°C | | 4 | | $G\Omega$ |
| | Cupply oursest per amplifier | | 25°C | | 0.35 | 0.55 | A |
| I _{CC} | Supply current per amplifier | | Full range | | | 0.7 | mA |

Full range is -55°C to 125°C.

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All typical values are at $T_A = 25$ °C.

All typical values are at T_A = 25°C. On products compliant to MIL-PRF-38535, Class B, this parameter is not production tested. (3)



6.16 Electrical Characteristics: LT1013DM, 5 V

at specified free-air temperature, $V_{CC+} = 5 \text{ V}$, $V_{CC-} = 0$, $V_{O} = 1.4 \text{ V}$, $V_{IC} = 0$ (unless otherwise noted)

| | PARAMETER | TEST CONDITIONS | T _A ⁽¹⁾ | MIN | TYP(2) | MAX | UNIT |
|-----------------|---|---|-------------------------------|-----|--------|------|------------|
| | | B 50.0 | 25°C | | 250 | 950 | |
| V_{IO} | Input offset voltage | $R_S = 50 \Omega$ | Full range | | 800 | 2000 | μV |
| | | $R_S = 50 \Omega, V_{IC} = 0.1 V$ | 125°C | | 560 | 1200 | |
| | Input offeet current | | 25°C | | 0.3 | 2 | ~ Λ |
| I _{IO} | Input offset current | | Full range | | | 10 | nA |
| | Innut high gurrant | | 25°C | | -18 | -50 | ~ Λ |
| I _{IB} | Input bias current | | Full range | | | -120 | nA |
| ., | Commence and institutions are a | December ded some | 25°C | 0 | | 3.5 | V |
| V_{ICR} | Common-mode input voltage range | Recommended range | Full range | 0 | | 3 | V |
| | | Output low, No load | 25°C | | 15 | 25 | |
| | | Output low, $R_L = 600 \Omega$ to GND | 25°C | | 5 | 10 | |
| | | Output low, R _L = 600 12 to GND | Full range | | | 18 | |
| V_{OM} | Maximum peak output voltage swing | Output low, I _{sink} = 1 mA | 25°C | | 220 | 350 | V |
| | 5g | Output high, No load | 25°C | 4 | 4.4 | | |
| | | Output high D 600 O to CND | 25°C | 3.4 | 4 | | |
| | | Output high, $R_L = 600 \Omega$ to GND | Full range | 3.1 | | | |
| A _{VD} | Large-signal differential voltage amplification | V_{O} = 5 mV to 4 V, R_{L} = 500 Ω | 25°C | | 1 | | V/µV |
| | Supply current per amplifier | | 25°C | - | 0.32 | 0.5 | mΛ |
| I _{CC} | Supply current per amplifier | | Full range | | | 0.65 | mA |

6.17 Operating Characteristics

 $V_{CC\pm}=\pm15~V,~V_{IC}=0,~T_A=25^{\circ}C$

| | PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|--------------------|---|---------------------|-----|------|-----|--------------------|
| SR | Slew rate | | 0.2 | 0.4 | | V/µs |
| ., | Facility last insultant acids welltone | f = 10 Hz | | 24 | | nV/√ Hz |
| V _n | Equivalent input noise voltage | f = 1 kHz | | 22 | | NV/√HZ |
| V _{N(PP)} | Peak-to-peak equivalent input noise voltage | f = 0.1 Hz to 10 Hz | | 0.55 | | μV |
| In | Equivalent input noise current | f = 10 Hz | | 0.07 | | pA/√Hz |

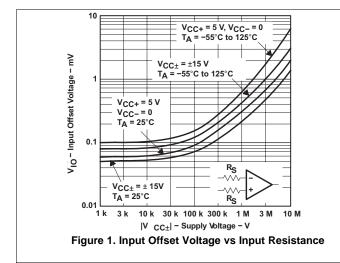
⁽¹⁾ Full range is -55°C to 125°C.
(2) All typical values are at T_A = 25°C.



6.18 Typical Characteristics

Table 1. Table of Graphs

| | | | FIGURE |
|--------------------|---|-----------------------|---------------------------------|
| V | Input offeet valtege | vs Input Resistance | Figure 1 |
| V _{IO} | Input offset voltage | vs Temperature | Figure 2 |
| ΔV_{IO} | Change in input offset voltage | vs Time | Figure 3 |
| I _{IO} | Input offset current | vs Temperature | Figure 4 |
| I _{IB} | Input bias current | vs Temperature | Figure 5 |
| V _{IC} | Common-mode input voltage | vs Input bias current | Figure 6 |
| | D''' and a Calmarka and a small Cara Cara | vs Load resistance | Figure 7, Figure 8 |
| A _{VD} | Differential voltage amplification | vs Frequency | Figure 9, Figure 10 |
| | Channel separation | vs Frequency | Figure 11 |
| | Output saturation voltage | vs Temperature | Figure 12 |
| CMRR | Common-mode rejection ratio | vs Frequency | Figure 13 |
| k _{SVR} | Supply-voltage rejection ratio | vs Frequency | Figure 14 |
| I _{CC} | Supply current | vs Temperature | Figure 15 |
| I _{OS} | Short-circuit output current | vs Time | Figure 16 |
| V _n | Equivalent input noise voltage | vs Frequency | Figure 17 |
| In | Equivalent input noise current | vs Frequency | Figure 17 |
| V _{N(PP)} | Peak-to-peak input noise voltage | vs Time | Figure 18 |
| , , | 5. | Small signal | Figure 19, Figure 21 |
| | Pulse response | Large signal | Figure 20, Figure 22, Figure 23 |
| | Phase shift | vs Frequency | Figure 9 |



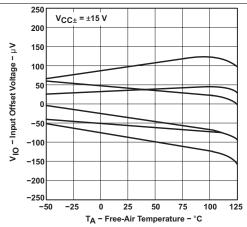
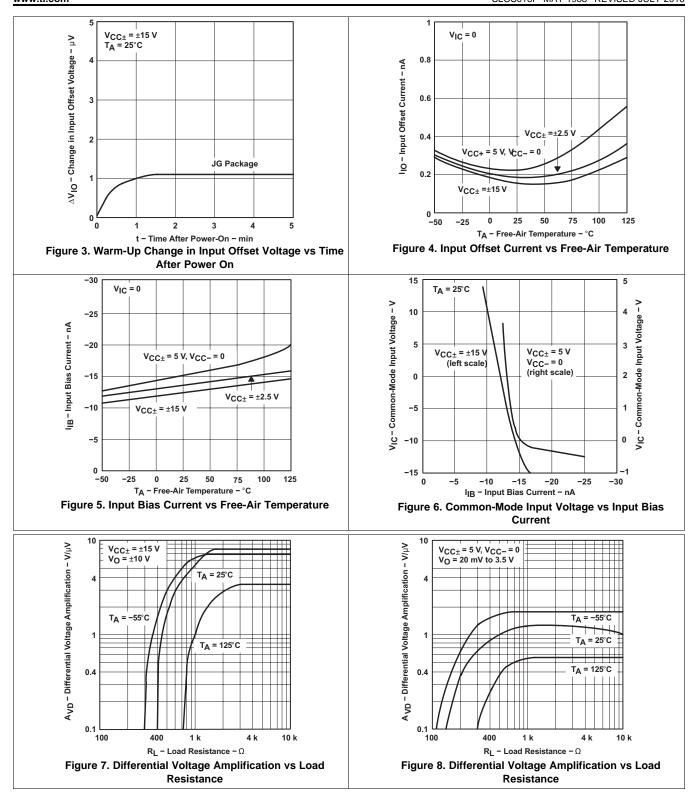
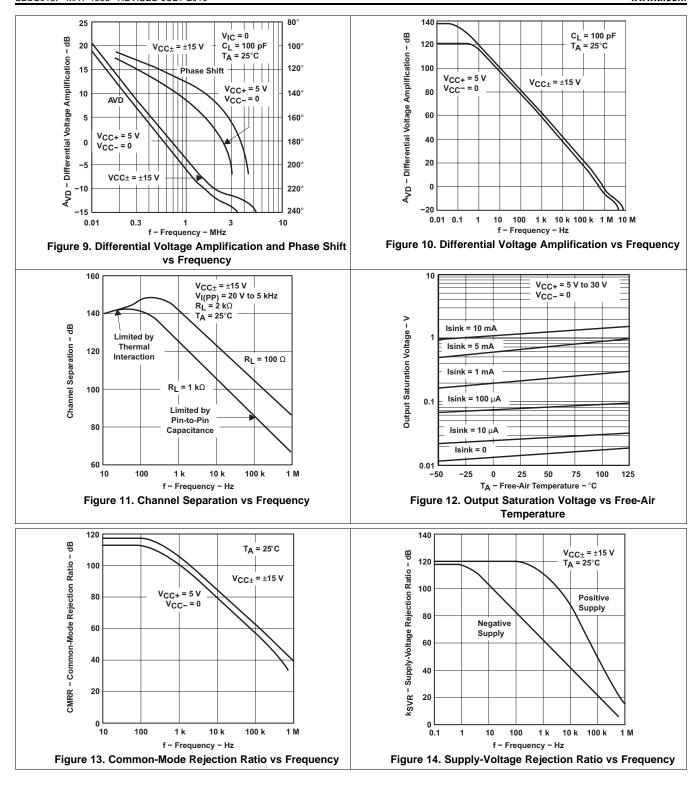


Figure 2. Input Offset Voltage of Representative Units vs Free-Air Temperature

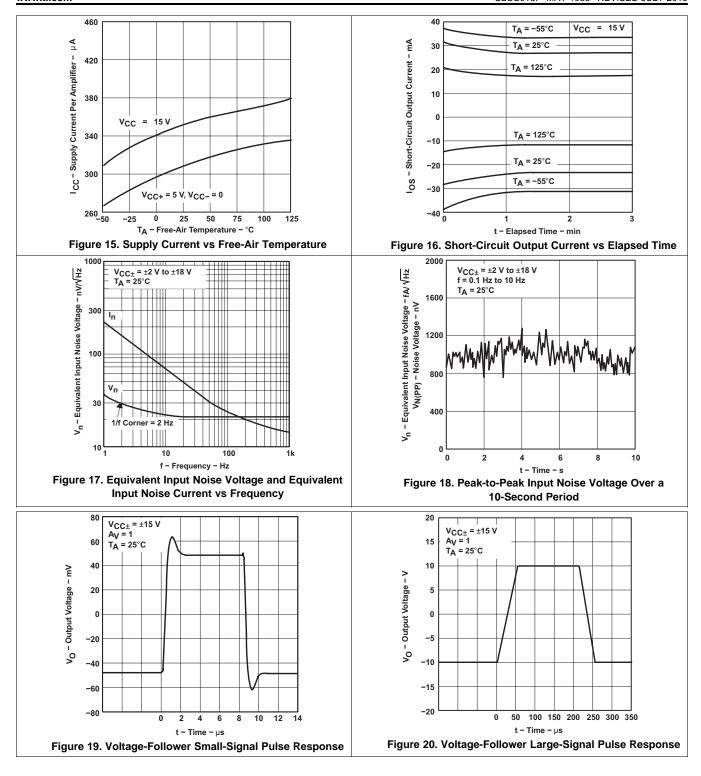




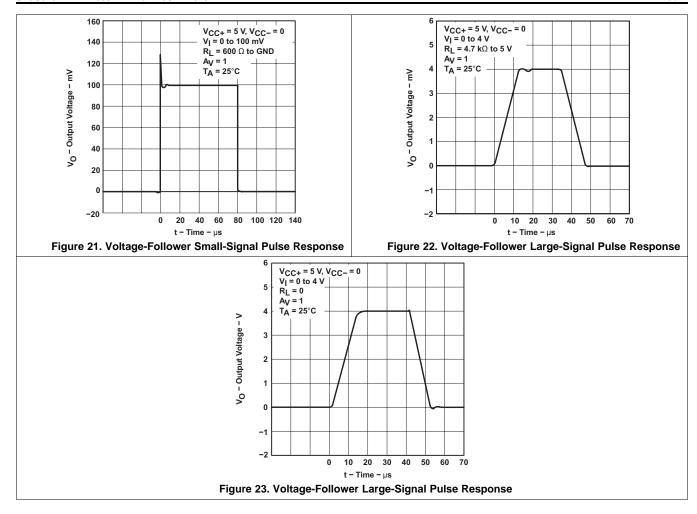












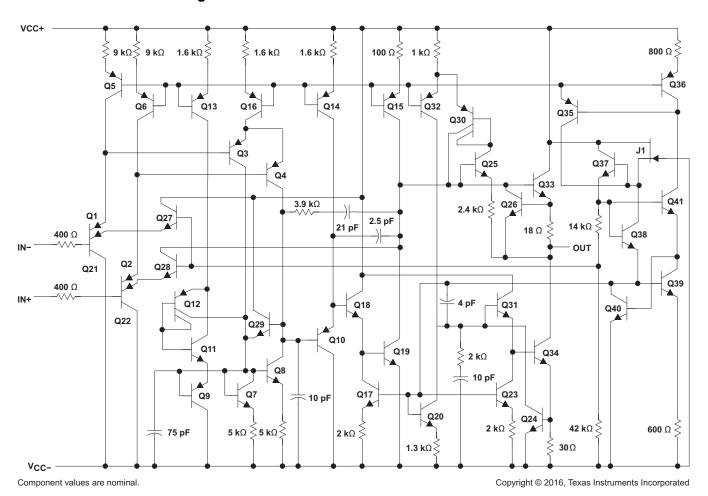


7 Detailed Description

7.1 Overview

The LT1013x device is a dual operational amplifier with low natural V_{IO} without programming memory that can be erased. There are no side effects from active V_{IO} correction used by other op amps. The LT1013x has built-in protection for input voltage below V_{CC-} . However, an external resistance must be add to protect the LT1013x from input voltage greater than V_{CC+} .

7.2 Functional Block Diagram



7.3 Feature Description

7.3.1 Input Resistors

For voltages less than V_{CC-} , a pair of 400- Ω resistors limit input current. These resistors have parasitic diodes to VCC+. Therefore, external series resistance is needed if input voltage exceed V_{CC+}

7.3.2 Output Stage

High output is provided by Q33 emitter for low output impedance. Q26 provides active current limiting for sourcing current.

Low output is provided by Q34 collector for lower output voltage near V_{CC} rail. Q24 provides active current limiting for sinking current.



Feature Description (continued)

7.3.3 Low-Supply Operation

The minimum supply voltage for proper operation of the LT1013x is 3.4 V (three NiCad batteries). Typical supply current at this voltage is 290 µA; therefore, power dissipation is only 1 mW per amplifier.

7.3.4 Output Phase Reversal Protection

The LT1013x is fully specified for single-supply operation ($V_{CC^-} = 0$). The common-mode input voltage range includes ground, and the output swings to within a few millivolts of ground.

Furthermore, the LT1013x has specific circuitry that addresses the difficulties of single-supply operation, both at the input and at the output. At the input, the driving signal can fall below 0 V, either inadvertently or on a transient basis. If the input is more than a few hundred millivolts below ground, the LT1013x is designed to deal with the following two problems that can occur:

- 1. On many other operational amplifiers, when the input is more than a diode drop below ground, unlimited current flows from the substrate (VCC- terminal) to the input, which can destroy the unit. On the LT1013x, the $400-\Omega$ resistors in series with the input protect the device, even when the input is 5 V below ground.
- 2. When the input is more than 400 mV below ground (at $T_A = 25^{\circ}\text{C}$), the input stage of similar operational amplifiers saturates, and phase reversal occurs at the output. This can cause lockup in servo systems. Because of unique phase-reversal protection circuitry (Q21, Q22, Q27, and Q28), the LT1013x outputs do not reverse, even when the inputs are at -1.5 V (see Figure 24).

This phase-reversal protection circuitry does not function when the other operational amplifier on the LT1013x is driven hard into negative saturation at the output. Phase-reversal protection does not work on amplifier 1 when amplifier 2 output is in negative saturation nor on amplifier 2 when amplifier 1 output is in negative saturation.

At the output, other single-supply designs either cannot swing to within 600 mV of ground or cannot sink more than a few micro amperes while swinging to ground. The all-npn output stage of the LT1013x maintains its low output resistance and high-gain characteristics until the output is saturated. In dual-supply operations, the output stage is free of crossover distortion.

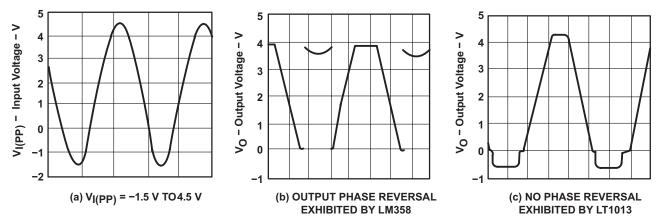


Figure 24. Voltage-Follower Response With Input Exceeding the Negative Common-Mode Input Voltage Range

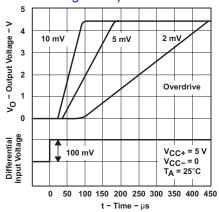
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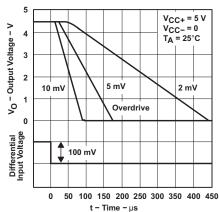


Feature Description (continued)

7.3.4.1 Comparator Applications

The single-supply operation of the LT1013x is well suited for use as a precision comparator with TTL-compatible output. In systems using both operational amplifiers and comparators, the LT1013x can perform multiple duties (see Figure 25 and Figure 26).





Various Input Overdrives

Figure 25. Low-to-High-Level Output Response for Figure 26. High-to-Low-Level Output Response for **Various Input Overdrives**

7.4 Device Functional Modes

The LT1013x dual operational amplifier amplifies a differential voltage applied to the inputs.



8 Application and Implementation

NOTE

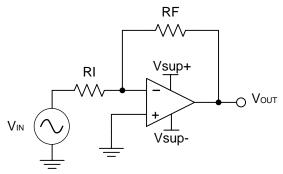
Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

8.1 Application Information

The LT1013x operational amplifiers are useful in a wide range of signal conditioning applications where high DC accuracy is needed.

8.2 Typical Application

A typical application for an operational amplifier in an inverting amplifier. This amplifier takes a positive voltage on the input and makes it a negative voltage of the same magnitude. In the same manner, it also makes negative voltages positive.



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Figure 27. Application Schematic

8.2.1 Design Requirements

The supply voltage must be chosen such that it is larger than the input voltage range and output range. For instance, this application scales a signal of ±0.5 V to ±1.8 V. Setting the supply at ±12 V is sufficient to accommodate this application.

8.2.2 Detailed Design Procedure

Determine the gain required by the inverting amplifier using Equation 1 and Equation 2:

$$A_{v} = \frac{VOUT}{VIN} \tag{1}$$

$$A_v = \frac{1.8}{-0.5} = -3.6 \tag{2}$$

Once the desired gain is determined, choose a value for RI or RF. Choosing a value in the $k\Omega$ range is desirable because the amplifier circuit will use currents in the milliamp range. This ensures the part does not draw too much current. This example chooses 10 $k\Omega$ for RI, which means 36 $k\Omega$ is used for RF. This was determined by Equation 3.

$$A_v = -\frac{RF}{RI} \tag{3}$$



Typical Application (continued)

8.2.3 Application Curve

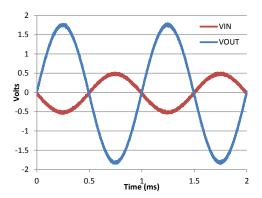


Figure 28. Input and Output Voltages of the Inverting Amplifier

9 Power Supply Recommendations

CAUTION

Supply voltages larger than 44 V for a single supply, or outside the range of ±22 V for a dual supply can permanently damage the device (see *Absolute Maximum Ratings*).

Place 0.1-µF bypass capacitors close to the power-supply pins to reduce errors coupling in from noisy or high impedance power supplies. For more detailed information on bypass capacitor placement, see *Layout*.

10 Layout

10.1 Layout Guidelines

For best operational performance of the device, use quality PCB layout practices, including:

- Noise can propagate into analog circuitry through the power pins of the circuit as a whole, as well as the
 operational amplifier. Bypass capacitors are used to reduce the coupled noise by providing low impedance
 power sources local to the analog circuitry.
 - Connect low-ESR, 0.1-µF ceramic bypass capacitors between each supply pin and ground, placed as close to the device as possible. A single bypass capacitor from V+ to ground is applicable for singlesupply applications.
- Separate grounding for analog and digital portions of circuitry is one of the simplest and most effective
 methods of noise suppression. One or more layers on multilayer PCBs are usually devoted to ground planes.
 A ground plane helps distribute heat and reduces EMI noise pickup. Make sure to physically separate digital
 and analog grounds, paying attention to the flow of the ground current.
- Run the input traces as far away from the supply or output traces as possible to reduce parasitic coupling. If it
 is not possible to keep them separate, it is much better to cross the sensitive trace perpendicular as opposed
 to in parallel with the noisy trace.
- Place the external components as close to the device as possible. Keeping RF and RG close to the inverting
 input minimizes parasitic capacitance, as shown in Layout Guidelines.
- Keep the length of input traces as short as possible. Always remember that the input traces are the most sensitive part of the circuit.
- Consider a driven, low-impedance guard ring around the critical traces. A guard ring can significantly reduce leakage currents from nearby traces that are at different potentials.



10.2 Layout Examples

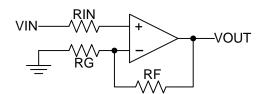


Figure 29. Operational Amplifier Schematic for Noninverting Configuration

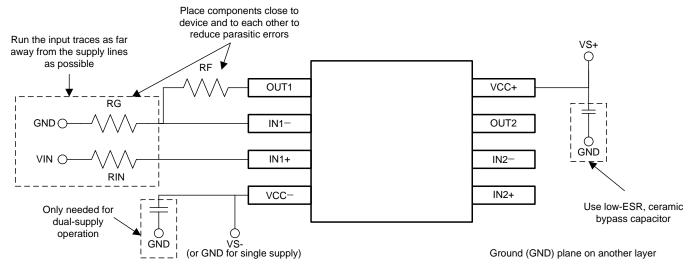


Figure 30. Operational Amplifier Board Layout for Noninverting Configuration



11 Device and Documentation Support

11.1 Device Support

11.1.1 Developmental Support

For developmental support, see the following:

LT1013-DIE

11.2 Related Links

The table below lists quick access links. Categories include technical documents, support and community resources, tools and software, and quick access to sample or buy.

Table 2. Related Links

| PARTS | PRODUCT FOLDER | SAMPLE & BUY | TECHNICAL DOCUMENTS | TOOLS & SOFTWARE | SUPPORT & COMMUNITY |
|------------|----------------|--------------|---------------------|---------------------|---------------------|
| LT1013 | Click here | Click here | Click here | Click here | Click here |
| LT1013D | Click here | Click here | Click here | Click here | Click here |
| LT1013M | Click here | Click here | Click here | Click here | Click here |
| LT1013AM | Click here | Click here | Click here | Click here | Click here |
| LT1013-DIE | Click here | Click here | Click here | Click here | Click here |

11.3 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on *Alert me* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

11.4 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

TI E2E™ Online Community T's Engineer-to-Engineer (E2E) Community. Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

Design Support *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

11.5 Trademarks

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11.6 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

11.7 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.



12 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

Submit Documentation Feedback





17-Mar-2017

PACKAGING INFORMATION

| Orderable Device | Status | Package Type | Package Drawing | Pins | Package Qty | Eco Plan | Lead/Ball Finish (6) | MSL Peak Temp | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|--------|--------------|--------------------|------|----------------|----------------------------|----------------------|--------------------|--------------|-----------------------------------|---------|
| 5962-88760012A | ACTIVE | LCCC | FK | 20 | 1 | TBD | POST-PLATE | N / A for Pkg Type | -55 to 125 | 5962- 88760012A LT1013AMFKB | Samples |
| 5962-8876001PA | ACTIVE | CDIP | JG | 8 | 1 | TBD | A42 | N / A for Pkg Type | -55 to 125 | 8876001PA LT1013AM | Samples |
| 5962-88760022A | ACTIVE | LCCC | FK | 20 | 1 | TBD | POST-PLATE | N / A for Pkg Type | -55 to 125 | 5962- 88760022A LT1013MFKB | Samples |
| 5962-8876002PA | ACTIVE | CDIP | JG | 8 | 1 | TBD | A42 | N / A for Pkg Type | -55 to 125 | 8876002PA LT1013M | Samples |
| LT1013AMFKB | ACTIVE | LCCC | FK | 20 | 1 | TBD | POST-PLATE | N / A for Pkg Type | -55 to 125 | 5962- 88760012A LT1013AMFKB | Samples |
| LT1013AMJG | ACTIVE | CDIP | JG | 8 | 1 | TBD | A42 | N / A for Pkg Type | -55 to 125 | LT1013AMJG | Samples |
| LT1013AMJGB | ACTIVE | CDIP | JG | 8 | 1 | TBD | A42 | N / A for Pkg Type | -55 to 125 | 8876001PA LT1013AM | Samples |
| LT1013CD | ACTIVE | SOIC | D | 8 | 75 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | 0 to 70 | 1013C | Samples |
| LT1013CDE4 | ACTIVE | SOIC | D | 8 | 75 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | 0 to 70 | 1013C | Samples |
| LT1013CDR | ACTIVE | SOIC | D | 8 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | 0 to 70 | 1013C | Samples |
| LT1013CDRE4 | ACTIVE | SOIC | D | 8 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | 0 to 70 | 1013C | Samples |
| LT1013CDRG4 | ACTIVE | SOIC | D | 8 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | 0 to 70 | 1013C | Samples |
| LT1013CP | ACTIVE | PDIP | Р | 8 | 50 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type | 0 to 70 | LT1013CP | Samples |
| LT1013CPE4 | ACTIVE | PDIP | Р | 8 | 50 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type | 0 to 70 | LT1013CP | Samples |
| LT1013DD | ACTIVE | SOIC | D | 8 | 75 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | 0 to 70 | 1013D | Samples |
| LT1013DDE4 | ACTIVE | SOIC | D | 8 | 75 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | 0 to 70 | 1013D | Samples |



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| Orderable Device | Status | Package Type | Package Drawing | Pins | | Eco Plan | Lead/Ball Finish | MSL Peak Temp | Op Temp (°C) | Device Marking | Sample |
|------------------|--------|--------------|--------------------|------|------|----------------------------|------------------|--------------------|--------------|----------------------------------|--------|
| | (1) | | | | Qty | (2) | (6) | (3) | | (4/5) | |
| LT1013DDG4 | ACTIVE | SOIC | D | 8 | 75 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | 0 to 70 | 1013D | Sample |
| LT1013DDR | ACTIVE | SOIC | D | 8 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | 0 to 70 | 1013D | Sample |
| LT1013DDRE4 | ACTIVE | SOIC | D | 8 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | 0 to 70 | 1013D | Sample |
| LT1013DID | ACTIVE | SOIC | D | 8 | 75 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 105 | 1013DI | Sample |
| LT1013DIDE4 | ACTIVE | SOIC | D | 8 | 75 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 105 | 1013DI | Sample |
| LT1013DIDG4 | ACTIVE | SOIC | D | 8 | 75 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 105 | 1013DI | Sample |
| LT1013DIDR | ACTIVE | SOIC | D | 8 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 105 | 1013DI | Sample |
| LT1013DIDRE4 | ACTIVE | SOIC | D | 8 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 105 | 1013DI | Sample |
| LT1013DIDRG4 | ACTIVE | SOIC | D | 8 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 105 | 1013DI | Sample |
| LT1013DIP | ACTIVE | PDIP | Р | 8 | 50 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type | -40 to 105 | LT1013DIP | Sample |
| LT1013DIPE4 | ACTIVE | PDIP | Р | 8 | 50 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type | -40 to 105 | LT1013DIP | Sample |
| LT1013DMD | ACTIVE | SOIC | D | 8 | 75 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -55 to 125 | 1013DM | Sample |
| LT1013DMDG4 | ACTIVE | SOIC | D | 8 | 75 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -55 to 125 | 1013DM | Sample |
| LT1013DP | ACTIVE | PDIP | Р | 8 | 50 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type | 0 to 70 | LT1013DP | Sample |
| LT1013DPE4 | ACTIVE | PDIP | Р | 8 | 50 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type | 0 to 70 | LT1013DP | Sample |
| LT1013MFKB | ACTIVE | LCCC | FK | 20 | 1 | TBD | POST-PLATE | N / A for Pkg Type | -55 to 125 | 5962- 88760022A LT1013MFKB | Sample |
| LT1013MJG | ACTIVE | CDIP | JG | 8 | 1 | TBD | A42 | N / A for Pkg Type | -55 to 125 | LT1013MJG | Sample |
| LT1013MJGB | ACTIVE | CDIP | JG | 8 | 1 | TBD | A42 | N / A for Pkg Type | -55 to 125 | 8876002PA LT1013M | Sample |

PACKAGE OPTION ADDENDUM



17-Mar-2017

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead/Ball Finish Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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OTHER QUALIFIED VERSIONS OF LT1013. LT1013M:

Catalog: LT1013

Military: LT1013M



PACKAGE OPTION ADDENDUM

17-Mar-2017

NOTE: Qualified Version Definitions:

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- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





| | Dimension designed to accommodate the component width |
|----|---|
| | Dimension designed to accommodate the component length |
| K0 | Dimension designed to accommodate the component thickness |
| W | Overall width of the carrier tape |
| P1 | Pitch between successive cavity centers |

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

| Device | Package Type | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|------------|-----------------|--------------------|---|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| LT1013CDR | SOIC | D | 8 | 2500 | 330.0 | 12.4 | 6.4 | 5.2 | 2.1 | 8.0 | 12.0 | Q1 |
| LT1013DDR | SOIC | D | 8 | 2500 | 330.0 | 12.4 | 6.4 | 5.2 | 2.1 | 8.0 | 12.0 | Q1 |
| LT1013DIDR | SOIC | D | 8 | 2500 | 330.0 | 12.4 | 6.4 | 5.2 | 2.1 | 8.0 | 12.0 | Q1 |

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*All dimensions are nominal

| 7 III dilitorio di Citto di Ci | | | | | | | | | | |
|--|--------------|-----------------|------|------|-------------|------------|-------------|--|--|--|
| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) | | | |
| LT1013CDR | SOIC | D | 8 | 2500 | 340.5 | 338.1 | 20.6 | | | |
| LT1013DDR | SOIC | D | 8 | 2500 | 340.5 | 338.1 | 20.6 | | | |
| LT1013DIDR | SOIC | D | 8 | 2500 | 340.5 | 338.1 | 20.6 | | | |

FK (S-CQCC-N**)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. Falls within JEDEC MS-004



D (R-PDSO-G8)

PLASTIC SMALL OUTLINE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AA.



D (R-PDSO-G8)

PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



JG (R-GDIP-T8)

CERAMIC DUAL-IN-LINE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification.
- E. Falls within MIL STD 1835 GDIP1-T8

P (R-PDIP-T8)

PLASTIC DUAL-IN-LINE PACKAGE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MS-001 variation BA.



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